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(54) PROBE FOR SEMICONDUCTOR INTEGRATED CIRCUIT TESTER

(57)Abstract:

PURPOSE: To obtain an inspection probe which can prevent deformation of a pad of a semiconductor integrated circuit in a semiconductor integrated circuit tester.

CONSTITUTION: One edge of a probe part 32 is fixed to a probe-retention substrate 36 and a contact part 34 is joined to and placed at the other edge. The contact part 34 is constituted by a hard conductive member with the probe part 32 and the probe part 32 is constituted by a plateshaped conductive member with plate spring elasticity. When a probe 30 is pressed, the probe part 32 fully absorbs the press force and prevents deformation of a pad 20.

